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METHODS, COMPLEXES, AND SYSTEMS FOR FORMING METAL-CONTAINING FILMS ON

SEMICONDUCTOR STRUCTURES

Amendments to the Claims

This listing of claims replaces all prior versions, and listings, of claims in the above-identified application:

18. (Original) A chemical vapor deposition system comprising:

a deposition chamber having a substrate positioned therein;

a vessel containing a precursor comprising one or more complexes of the

formula:

 $[(R^1)NC(R^2)C(R^3)N(R^4)]_xML_y$

wherein:

M is a group IVB, VB, or VIB metal:

each R¹, R², R³, and R⁴ is independently H or an organic group;

L is selected from the group of CO, NO, CN, CS, CNR5, R6CN, or R7,

wherein each R⁵, R⁶, and R⁷ group is independently an organic group;

x = 1 to 4; and

y = 1 to 4; and

a source of inert carrier gas for transferring the precursor to the chemical vapor deposition chamber.

19. (Original) A chemical vapor deposition system comprising:

a deposition chamber having a substrate positioned therein;

a vessel containing a precursor composition comprising one or more complexes of the formula:

 $[(R^1)NC(R^2)C(R^3)N(R^4)]_*ML_*$

wherein:

M is a Group IVB, VB, or VIB metal;

each R1, R2, R3, and R4 is independently H or an organic group;

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each L is independently CO, NO, CN, CS, CNR⁵, R⁶CN, or R⁷, wherein each R⁵, R⁶, and R⁷ group is independently an organic group;

x = 1 to 4; and

y = 1 to 4.

- 20. (Currently Amended) The system of claim 38 [[19]] wherein the deposition chamber is adapted for forming a metal-containing film comprising vaporizing the precursor composition and directing it toward the semiconductor substrate or substrate assembly using a chemical vapor depositional technique.
- 21. (Original) The system of claim 20 wherein the chemical vapor deposition technique comprises flash vaporization, bubbling, microdroplet formation, or combinations thereof.
- (Original) The system of claim 20 wherein the precursor composition is vaporized in the presence of a carrier gas.
- 23. (Original) The system of claim 20 wherein the precursor composition is vaporized in the presence of a reaction gas.
- 24. (Original) The system of claim 23 wherein the reaction gas is selected from the group of H₂, SiH₄, Si₂H₆, NH₃, N₂H₄, PH₃, AsH₃, GeH₄, t-BuSbMe₂, H₂S, H₂Se, Te(allyl)₂, and combinations thereof.
- 25. (Original) The system of claim 19 wherein each R¹, R², R³, and R⁴ group is independently H or a (C₁-C₃₀)organic group.
- 26. (Original) The system of claim 19 wherein the complex is a monomer.

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27. (Original) The system of claim 19 wherein each R¹, R², R³, and R⁴ group is independently H or a (C₁-C₄)alkyl moiety.

- 28. (Original) The system of claim 19 wherein R⁷ is cyclopentadienyl or a substituted cyclopentadienyl.
- 29. (Original) The system of claim 19 wherein the precursor composition is a liquid.
- 30. (Original) The system of claim 19 wherein the metal is a Group VB metal.
- 31. (Original) The system of claim 30 wherein the metal is vanadium.
- 32. (Currently Amended) The system of claim 20 [[19]] wherein the metal-containing film is a Group IVB, VB, or VIB metal alloy film.
- 33. (Original) A chemical vapor deposition system comprising:
 - a deposition chamber having a semiconductor substrate or substrate assembly positioned therein;
 - a vessel containing a precursor composition comprising one or more complexes of the formula:

 $[(R^1)NC(R^2)C(R^3)N(R^4)]_xML_y$

wherein:

M is a Group IVB, VB, or VIB metal; each R^1 , R^2 , R^3 , and R^4 is independently H or an organic group; each L is independently CO, NO, CN, CS, CNR⁵, R⁶CN, or R⁷, wherein each R^4 , R^6 , and R^7 group is independently an organic group; x = 1 to 4; and

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y = 1 to 4.

- 34. (Original) The system of claim 33 wherein each R¹, R², R³, and R⁴ is independently H or a (C₁-C₂₀)organic group.
- 35. (Original) The system of claim 33 wherein the complex is a monomer.
- 36. (Original) The system of claim 33 wherein each R1, R2, R3, and R4 group is independently H or a (C₁-C₄)alkyl moiety.
- 37. (Original) The system of claim 33 wherein R⁷ is cyclopentadienyl or a substituted cyclopentadienyl.
- 38. (Currently Amended) A chemical vapor deposition system comprising:

a deposition chamber having a semiconductor substrate or substrate assembly positioned positional therein;

a vessel containing a precursor composition comprising one or more liquid complexes of the formula:

 $[(R^1)NC(R^2)C(R^3)N(R^4)]_xML_x$

wherein:

M is a Group IVB, VB, or VIB metal; each R1, R2, R3, and R4 independently H or a (C1 - C30) organic group; each L is independently CO, NO, CN, CS, CNR⁵, R⁶CN, or R⁷, wherein each R⁵, R⁶, and R⁷ group is independently an organic group; x = 1 to 4; and y = 1 to 4.